MACHINED BOARD STACKING STRIPS

Mates with: SS, SD, HSS, SL, SDL, ESS, ESD

FEATURES

- Low profile design achieves (3.89 mm) .153" board spacings when mated with SL Series.
- Approach the reliability of a permanent connection with the flexibility of a separable connection.

SPECIFICATIONS


Insulator Material:
Black Glass Filled Polyester (BBS, BBD, BBL)
Black High Temp Nylon (BDL)
Black Liquid Crystal Polymer (BHS)

Temperature Range:
-55°C to +125°C

Terminal Material:
Phosphor Bronze or Brass

Plating:
Au or Sn over 50µ" (1.27 µm) Ni

RoHS Compliant:
Yes

Lead-Free Solderable:
Wave only (BBS, BBD, BBL, BDL)
Wave, or reflow with all Au (BHS)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality

Note: Some lengths, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice.